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## MC14013B

## Dual Type D Flip-Flop

The MC14013B dual type D flip-flop is constructed with MOS P -channel and N -channel enhancement mode devices in a single monolithic structure. Each flip-flop has independent Data, (D), Direct Set, (S), Direct Reset, (R), and Clock (C) inputs and complementary outputs ( Q and $\overline{\mathrm{Q}}$ ). These devices may be used as shift register elements or as type T flip-flops for counter and toggle applications.

## Features

- Static Operation
- Diode Protection on All Inputs
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Logic Edge-Clocked Flip-Flop Design
- Logic State is Retained Indefinitely with Clock Level either High or Low; Information is Transferred to the Output only on the Positive-going Edge of the Clock Pulse
- Capable of Driving Two Low-power TTL Loads or One Low-power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD4013B
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | DC Supply Voltage Range | -0.5 to +18.0 | V |
| $\mathrm{~V}_{\text {in }}, \mathrm{V}_{\text {out }}$ | Input or Output Voltage Range <br> (DC or Transient) | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $\mathrm{I}_{\text {in }}, \mathrm{I}_{\text {out }}$ | Input or Output Current <br> (DC or Transient) per Pin | $\pm 10$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation, per Package <br> (Note 1) | 500 | mW |
| $\mathrm{~T}_{\mathrm{A}}$ | Ambient Temperature Range | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature <br> (8-Second Soldering) | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: $-7.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ From $65^{\circ} \mathrm{C}$ To $125^{\circ} \mathrm{C}$

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {in }}$ and $\mathrm{V}_{\text {out }}$ should be constrained to the range $\mathrm{V}_{\mathrm{SS}} \leq\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{DD}}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either $\mathrm{V}_{\mathrm{SS}}$ or $\mathrm{V}_{\mathrm{DD}}$ ). Unused outputs must be left open.

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| SOIC-14 | SOEIAJ-14 | TSSOP-14 |
| :--- | :--- | :--- |
| D SUFFIX | F SUFFIX | DT SUFFIX |
| CASE 751A | CASE 965 | CASE 948G |

PIN ASSIGNMENT

| $Q _ { A } \longdiv { 1 \bullet }$ | 14 | $V_{D D}$ |
| :---: | :---: | :---: |
| $\bar{Q}_{\text {A }} \mathrm{C} 2$ | 13 | $\mathrm{Q}_{\mathrm{B}}$ |
| $\mathrm{C}_{\mathrm{A}} \mathrm{C}^{\text {a }}$ | 12 | $\mathrm{Q}_{B}$ |
| $\mathrm{R}_{\mathrm{A}} ¢ 4$ | 11 | $\mathrm{C}_{\mathrm{B}}$ |
| $\mathrm{D}_{\mathrm{A}} ¢ 5$ | 10 | $\mathrm{R}_{\mathrm{B}}$ |
| $\mathrm{Sa}_{\text {A }} 6$ | 9 | $\mathrm{D}_{\mathrm{B}}$ |
| $\mathrm{V}_{\text {SS }} ¢ 7$ | 8 | $S_{B}$ |

## MARKING DIAGRAMS



TSSOP-14

$$
\begin{array}{ll}
\text { A } & =\text { Assembly Location } \\
\text { WL, L } & =\text { Wafer Lot } \\
\text { YY, Y } & =\text { Year } \\
\text { WW, W } & =\text { Work Week } \\
\text { G or } & =\text { Pb-Free Package }
\end{array}
$$

(Note: Microdot may be in either location)

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## MC14013B

TRUTH TABLE

| Inputs |  |  |  | Outputs |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Clock ${ }^{\dagger}$ | Data | Reset | Set | Q | Q |
| ת | 0 | 0 | 0 | 0 | 1 |
| ת | 1 | 0 | 0 | 1 | 0 |
| $\checkmark$ | X | 0 | 0 | Q | $\overline{\mathrm{Q}}$ |
| X | X | 1 | 0 | 0 | 1 |
| X | X | 0 | 1 | 1 | 0 |
| X | X | 1 | 1 | 1 | 1 |

## BLOCK DIAGRAM



ORDERING INFORMATION

| Device | Package |  |
| :--- | :---: | :---: |
| MC14013BDG | SOIC-14 <br> (Pb-Free) | 55 Units / Rail |
| NLV14013BDG* | SOIC-14 <br> (Pb-Free) | 55 Units / Rail |
| MC14013BDR2G | SOIC-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| NLV14013BDR2G* | SOIC-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| MC14013BDTR2G | TSSOP-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| NLV14013BDTR2G* | TSSOP-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| MC14013BFG | SOEIAJ-14 <br> (Pb-Free) | 2000 Units / Rail |
| MC14013BFELG | SOEIAJ-14 <br> (Pb-Free) | Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Characteristic | Symbol | $V_{D D}$ Vdc | $-55^{\circ} \mathrm{C}$ |  | $25^{\circ} \mathrm{C}$ |  |  | $125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Typ ${ }^{(2)}$ | Max | Min | Max |  |
| Output Voltage $V_{\text {in }}=V_{D D} \text { or } 0$ | $\mathrm{V}_{\text {OL }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ |  | $\begin{aligned} & \hline 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ |  | $\begin{aligned} & \hline 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | Vdc |
| $\mathrm{V}_{\text {in }}=0$ or $\mathrm{V}_{\mathrm{DD}}$ ( "1" Level | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | $\begin{gathered} \hline 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} \hline 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | Vdc |
|   <br> Input Voltage $" 0 "$ Level <br> $\left(V_{O}=4.5\right.$ or 0.5 Vdc$)$  <br> $\left(\mathrm{V}_{\mathrm{O}}=9.0\right.$ or 1.0 Vdc$)$  <br> $\left(\mathrm{V}_{\mathrm{O}}=13.5\right.$ or 1.5 Vdc$)$  <br>   | $\mathrm{V}_{\mathrm{IL}}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | - | $\begin{aligned} & 2.25 \\ & 4.50 \\ & 6.75 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | - | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | Vdc |
| $\begin{aligned} & \left(\mathrm{V}_{\mathrm{O}}=0.5 \text { or } 4.5 \mathrm{Vdc}\right) \quad \text { " } 1 " \text { Level } \\ & \left(\mathrm{V}_{\mathrm{O}}=1.0 \text { or } 9.0 \mathrm{Vdc}\right) \\ & \left(\mathrm{V}_{\mathrm{O}}=1.5 \text { or } 13.5 \mathrm{Vdc}\right) \end{aligned}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 7.0 \\ & 11 \end{aligned}$ | - | $\begin{aligned} & 3.5 \\ & 7.0 \\ & 11 \end{aligned}$ | $\begin{aligned} & 2.75 \\ & 5.50 \\ & 8.25 \end{aligned}$ | - | $\begin{aligned} & \hline 3.5 \\ & 7.0 \\ & 11 \end{aligned}$ |  | Vdc |
| $\begin{array}{\|ll} \hline \text { Output Drive Current } & \\ \left(\mathrm{V}_{\mathrm{OH}}=2.5 \mathrm{Vdc}\right) & \text { Source } \\ \left(\mathrm{V}_{\mathrm{OH}}=4.6 \mathrm{Vdc}\right) & \\ \left(\mathrm{V}_{\mathrm{OH}}=9.5 \mathrm{Vdc}\right) & \\ \left(\mathrm{V}_{\mathrm{OH}}=13.5 \mathrm{Vdc}\right) & \end{array}$ | IOH | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} -3.0 \\ -0.64 \\ -1.6 \\ -4.2 \end{gathered}$ |  | $\begin{gathered} -2.4 \\ -0.51 \\ -1.3 \\ -3.4 \end{gathered}$ | $\begin{gathered} -4.2 \\ -0.88 \\ -2.25 \\ -8.8 \end{gathered}$ | - | $\begin{aligned} & -1.7 \\ & -0.36 \\ & -0.9 \\ & -2.4 \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \\ & - \end{aligned}$ | mAdc |
| $\begin{array}{ll} (\mathrm{V} \text { OL }=0.4 \mathrm{Vdc}) & \text { Sink } \\ (\mathrm{V} \mathrm{OL}=0.5 \mathrm{Vdc}) & \\ \left(\mathrm{V}_{\mathrm{OL}}=1.5 \mathrm{Vdc}\right) & \end{array}$ | loL | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 0.64 \\ 1.6 \\ 4.2 \end{gathered}$ | - | $\begin{gathered} \hline 0.51 \\ 1.3 \\ 3.4 \end{gathered}$ | $\begin{gathered} \hline 0.88 \\ 2.25 \\ 8.8 \end{gathered}$ | - | $\begin{gathered} \hline 0.36 \\ 0.9 \\ 2.4 \end{gathered}$ | - | mAdc |
| Input Current | $\mathrm{l}_{\text {in }}$ | 15 | - | $\pm 0.1$ | - | $\pm 0.00001$ | $\pm 0.1$ | - | $\pm 1.0$ | $\mu \mathrm{Adc}$ |
| Input Capacitance $\left(\mathrm{V}_{\text {in }}=0\right)$ | $\mathrm{C}_{\text {in }}$ | - | - | - | - | 5.0 | 7.5 | - | - | pF |
| Quiescent Current (Per Package) | IDD | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & \hline 1.0 \\ & 2.0 \\ & 4.0 \end{aligned}$ | - | $\begin{aligned} & \hline 0.002 \\ & 0.004 \\ & 0.006 \end{aligned}$ | $\begin{aligned} & \hline 1.0 \\ & 2.0 \\ & 4.0 \end{aligned}$ | - | $\begin{gathered} 30 \\ 60 \\ 120 \end{gathered}$ | $\mu \mathrm{Adc}$ |
| Total Supply Current ${ }^{(3)}$ (4) (Dynamic plus Quiescent, Per Package) ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ on all outputs, all buffers switching) | $\mathrm{I}_{T}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} \mathrm{I}_{\mathrm{T}} & =(0.75 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ \mathrm{I}_{\mathrm{T}} & =(1.5 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ \mathrm{I}_{\mathrm{T}} & =(2.3 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \end{aligned}$ |  |  |  |  |  |  | $\mu \mathrm{Adc}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
3. The formulas given are for the typical characteristics only at $25^{\circ} \mathrm{C}$.
4. To calculate total supply current at loads other than 50 pF :

$$
\mathrm{I}_{\mathrm{T}}\left(\mathrm{C}_{\mathrm{L}}\right)=\mathrm{I}_{\mathrm{T}}(50 \mathrm{pF})+\left(\mathrm{C}_{\mathrm{L}}-50\right) \text { Vfk }
$$

where: $I_{T}$ is in $\mu \mathrm{A}$ (per package), $\mathrm{C}_{\mathrm{L}}$ in $\mathrm{pF}, \mathrm{V}=\left(\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\mathrm{SS}}\right)$ in volts, f in kHz is input frequency, and $\mathrm{k}=0.002$.

SWITCHING CHARACTERISTICS (Note 5) ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Characteristic | Symbol | $\mathrm{V}_{\mathrm{DD}}$ | Min | Typ (Note 6) | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Rise and Fall Time $\begin{aligned} & \mathrm{t}_{\mathrm{TLH}}, \mathrm{t}_{\mathrm{THL}}=(1.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+25 \mathrm{~ns} \\ & \mathrm{t}_{\mathrm{TLH}}, \mathrm{t}_{\mathrm{THL}}=(0.75 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+12.5 \mathrm{~ns} \\ & \mathrm{t}_{\mathrm{TLH}}, \mathrm{t}_{\mathrm{THL}}=(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+9.5 \mathrm{~ns} \end{aligned}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{TLLH}}, \\ & \mathrm{t}_{\mathrm{TH}} \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | $\begin{gathered} 100 \\ 50 \\ 40 \end{gathered}$ | $\begin{gathered} 200 \\ 100 \\ 80 \end{gathered}$ | ns |
| Propagation Delay Time <br> Clock to Q, $\bar{Q}$ <br> $t_{\text {PLH }}, t_{P H L}=(1.7 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+90 \mathrm{~ns}$ <br> $t_{\text {PLH }}, \mathrm{t}_{\mathrm{PHL}}=(0.66 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+42 \mathrm{~ns}$ <br> $t_{\text {PLH }}, t_{\text {PHL }}=(0.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+25 \mathrm{~ns}$ <br> Set to Q, $\bar{Q}$ <br> $t_{\text {PLH }}, t_{P H L}=(1.7 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+90 \mathrm{~ns}$ <br> $t_{\text {PLH }}, t_{\text {PHL }}=(0.66 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+42 \mathrm{~ns}$ <br> $t_{\text {PLH }}, t_{P H L}=(0.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+25 \mathrm{~ns}$ <br> Reset to $\mathrm{Q}, \overline{\mathrm{Q}}$ <br> $t_{\text {PLH }}, \mathrm{t}_{\mathrm{PHL}}=(1.7 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+265 \mathrm{~ns}$ <br> $t_{\text {PLH }}, \mathrm{t}_{\mathrm{PHL}}=(0.66 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+67 \mathrm{~ns}$ <br> $\mathrm{t}_{\mathrm{PLH}}, \mathrm{t}_{\mathrm{PHL}}=(0.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+50 \mathrm{~ns}$ | $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | 5.0 <br> 10 <br> 15 <br>  <br> 5.0 <br> 10 <br> 15 <br>  <br> .0 <br> 10 <br> 15 |  | 175 <br> 75 <br> 50 <br>  <br> 175 <br> 75 <br> 50 <br>  <br>  <br> 225 <br> 100 <br> 75 | 350 <br> 150 <br> 100 <br>  <br> 350 <br> 150 <br> 100 <br>  <br> 450 <br> 200 <br> 150 | ns |
| Setup Times (Note 7) | $\mathrm{t}_{\text {su }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 40 \\ & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & 20 \\ & 10 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | ns |
| Hold Times (Note 7) | $\mathrm{th}_{\text {h }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 40 \\ & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & 20 \\ & 10 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | ns |
| Clock Pulse Width | twL, twh | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} 250 \\ 100 \\ 70 \end{gathered}$ | $\begin{gathered} 125 \\ 50 \\ 35 \end{gathered}$ |  | ns |
| Clock Pulse Frequency | $\mathrm{f}_{\mathrm{cl}}$ | $\begin{gathered} \hline 5.0 \\ 10 \\ 15 \end{gathered}$ | $\begin{aligned} & - \\ & \text { - } \end{aligned}$ | $\begin{gathered} 4.0 \\ 10 \\ 14 \end{gathered}$ | $\begin{aligned} & 2.0 \\ & 5.0 \\ & 7.0 \end{aligned}$ | MHz |
| Clock Pulse Rise and Fall Time | $\begin{aligned} & \mathrm{t}_{\mathrm{T} \mathrm{LH}} \\ & \mathrm{t}_{\mathrm{TH}} \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & \hline 15 \\ & 5.0 \\ & 4.0 \end{aligned}$ | $\mu \mathrm{s}$ |
| Set and Reset Pulse Width | $\mathrm{t}_{\mathrm{WL}}$, twh | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} 250 \\ 100 \\ 70 \end{gathered}$ | $\begin{gathered} 125 \\ 50 \\ 35 \end{gathered}$ |  | ns |
| Removal Times Set <br> Reset | $\mathrm{t}_{\text {rem }}$ | 5 <br> 10 <br> 15 <br> 5 <br> 10 <br> 15 | 80 <br> 45 <br> 35 <br> 50 <br> 30 <br> 25 | $\begin{gathered} 0 \\ 5 \\ 5 \\ \hline-35 \\ -10 \\ -5 \end{gathered}$ |  | ns |

5. The formulas given are for the typical characteristics only at $25^{\circ} \mathrm{C}$.
6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
7. Data must be valid for 250 ns with a 5 V supply, 100 ns with 10 V , and 70 ns with 15 V .

LOGIC DIAGRAM (1/2 of Device Shown)



Inputs R and S low.
Figure 1. Dynamic Signal Waveforms (Data, Clock, and Output)


Figure 2. Dynamic Signal Waveforms (Set, Reset, Clock, and Output)

TYPICAL APPLICATIONS
n-STAGE SHIFT REGISTER


BINARY RIPPLE UP-COUNTER (Divide-by-2n)


## MC14013B

## PACKAGE DIMENSIONS



## MC14013B

## PACKAGE DIMENSIONS

TSSOP-14
CASE 948G
ISSUE B

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## MC14013B

## PACKAGE DIMENSIONS

SOEIAJ-14
CASE 965
ISSUE B


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE

MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH
DIMENSION AT MAXIMUM MATERIAL CONDITION DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE
BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 ( 0.018 ).

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | --- | 2.05 | --- | 0.081 |
| $\mathrm{A}_{1}$ | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 9.90 | 10.50 | 0.390 | 0.413 |
| E | 5.10 | 5.45 | 0.201 | 0.215 |
| e | 1.27 BSC |  | 0.050 BSC |  |
| $\mathrm{H}_{\mathrm{E}}$ | 7.40 | 8.20 | 0.291 | 0.323 |
| L | 0.50 | 0.85 | 0.020 | 0.033 |
| $L_{E}$ | 1.10 | 1.50 | 0.043 | 0.059 |
| M | $0^{\circ}$ | $10^{\circ}$ | $0^{\circ}$ | $10^{\circ}$ |
| $Q_{1}$ | 0.70 | 0.90 | 0.028 | 0.035 |
| Z | --- | 1.42 | --- | 0.056 |

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